



MOUNTING PROCEDURE

1. Drill thermal vias through PCB and fill with solder, such as SN63 type.
2. Solder part in place using SN63 type solder with controlled temperature iron (700°F).
3. To ensure good thermal connectivity to heat sink, which is critical for proper operation drill and tap heatsink and mount PCB board to heat sink using screws.

Dimension given in inches [millimeters]

For best thermal performance the PCB should be soldered to the heat sink.